

### IN THE CLAIMS:

1. (Original) A curable organopolysiloxane composition comprising:

(A) a straight-chain organopolysiloxane having per molecule at least two silicon-bonded alkenyl groups and at least one silicon-bonded aryl group;

(B) a branched-chain organopolysiloxane with siloxane units represented by the general formula:



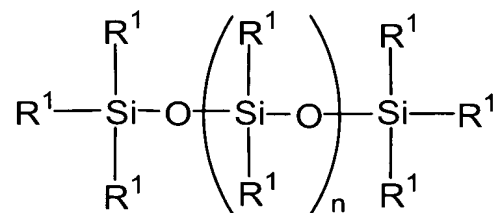
where R is a substituted or unsubstituted monovalent hydrocarbon group, and where component (B) has per molecule, at least one silicon-bonded alkenyl group and at least one silicon-bonded aryl group, and where component (B) is used in a weight ratio of 1/99 to 99/1 based on the weight of component (A);

(C) an organopolysiloxane having per molecule at least two silicon-bonded hydrogen atoms, where component (C) is used in an amount of 1 to 200 parts by weight for each 100 parts by weight of the total weight of parts (A) and (B); and

(D) a hydrosilylation catalyst in an amount sufficient to promote curing of the composition.

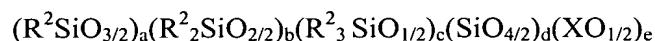
2. (Original) The curable organopolysiloxane composition of claim 1, where component (A) has a content of silicon-bonded aryl groups not less than 40 mole % of all silicon-bonded organic groups in component (A).

3. (Original) The curable organopolysiloxane composition of claim 1, where component (A) is an organopolysiloxane represented by the general formula:



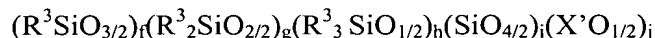
where each R<sup>1</sup> comprises the same or different substituted or unsubstituted monovalent hydrocarbon groups, at least two R<sup>1</sup>'s comprise alkenyl groups, at least one R<sup>1</sup> comprises an aryl group, and *n* is an integer from 5 to 1000.

4. (Original) The curable organopolysiloxane composition of claim 1, where component (B) has average unit formula:



where each  $R^2$  is the same or different substituted or unsubstituted monovalent hydrocarbon group, 0.1 to 40 mole % of all  $R^2$ 's are alkenyl groups, more than 10 mole % of all  $R^2$ 's are aryl groups, X is a hydrogen atom or an alkyl group,  $a$  is a positive number,  $b$  is 0 or a positive number,  $c$  is 0 or a positive number,  $d$  is 0 or a positive number,  $e$  is 0 or a positive number,  $b/a$  is 0 to 10,  $c/a$  is 0 to 0.5,  $d/(a + b + c + d)$  is 0 to 0.3, and  $e/(a + b + c + d)$  is 0 to 0.4.

5. (Original) The curable organopolysiloxane composition of claim 1, where all or a portion of component (C) has average unit formula:



where each  $R^3$  is the same or different alkenyl groups, substituted or unsubstituted monovalent hydrocarbon groups, or hydrogen atoms; 0.1 to 40 mole % of all  $R^3$ 's are hydrogen atoms; more than 10 mole % of all  $R^3$ 's are aryl groups;  $X'$  is a hydrogen atom or an alkyl group,  $f$  is a positive number,  $g$  is 0 or a positive number,  $h$  is 0 or a positive number,  $i$  is 0 or a positive number,  $j$  is 0 or a positive number,  $g/f$  is 0 to 10,  $h/f$  is 0 to 0.5,  $i/(f + g + h + i)$  is 0 to 0.3, and  $j/(f + g + h + i)$  is 0 to 0.4.

6. (Currently Amended) The curable organopolysiloxane composition of claim 1, where an index of refraction at 25°C ~~[[in]]~~ for visible light having a wavelength of 589 nm passing through an object obtained by curing the curable organopolysiloxane composition of ~~any of claims~~ claim 1 ~~[[to 5]]~~ is equal to or exceeds 1.5.

7. (Currently Amended) The curable organopolysiloxane composition of claim 1, where ~~coefficient of light permeation~~ permeability at 25°C for visible light passing through an object obtained by curing the curable organopolysiloxane composition of ~~any of claims~~ claim 1 ~~[[to 5]]~~ is equal to or exceeds 80%.

8. (Currently amended) A semiconductor device coated with a cured coating made from the curable organopolysiloxane according to ~~any of claims 1 to 5~~ claim 1.

9. (Original) The semiconductor device of claim 8, where said semiconductor device comprises a light-emitting element.